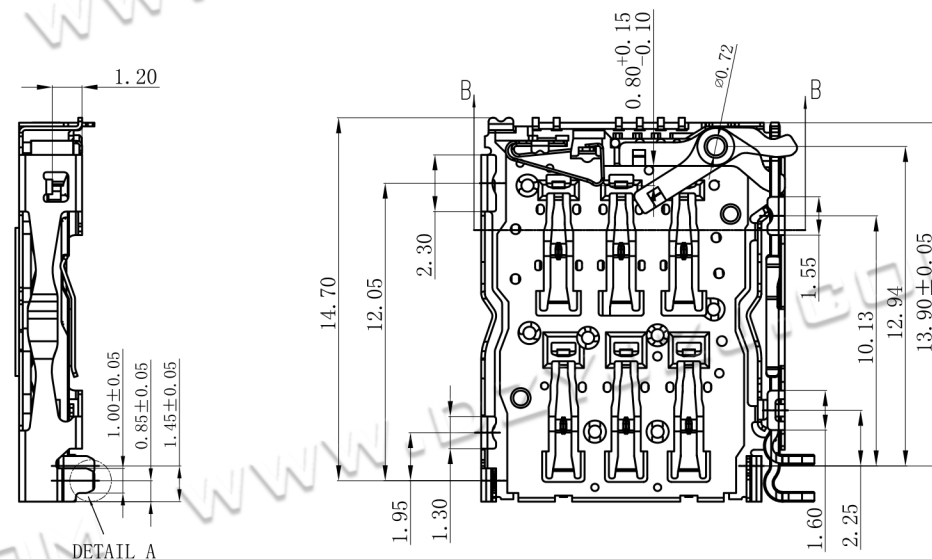
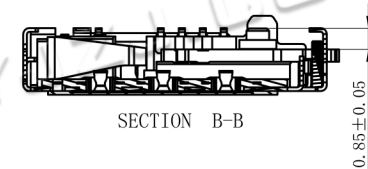
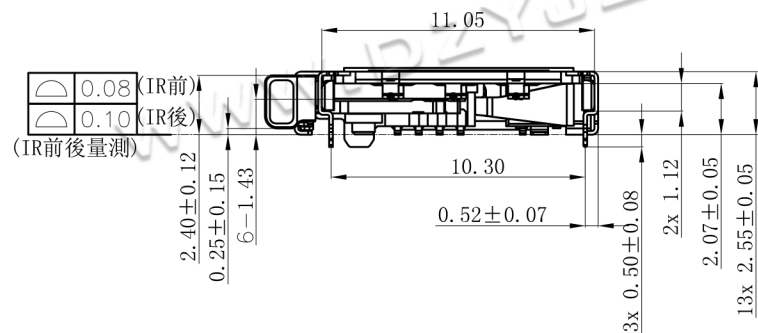
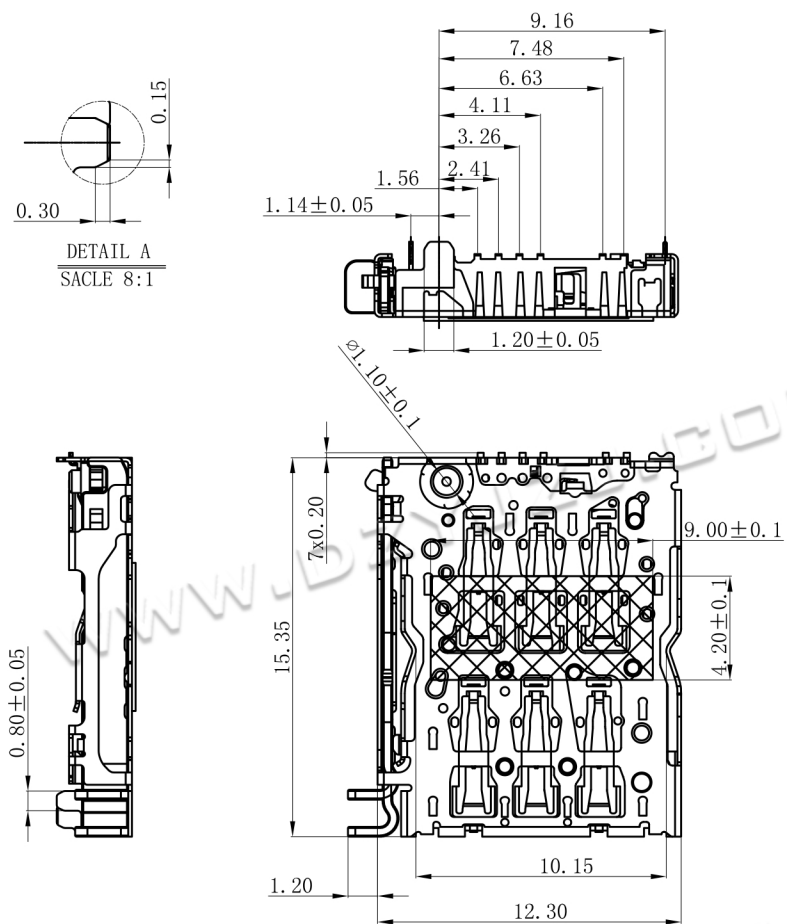
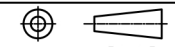
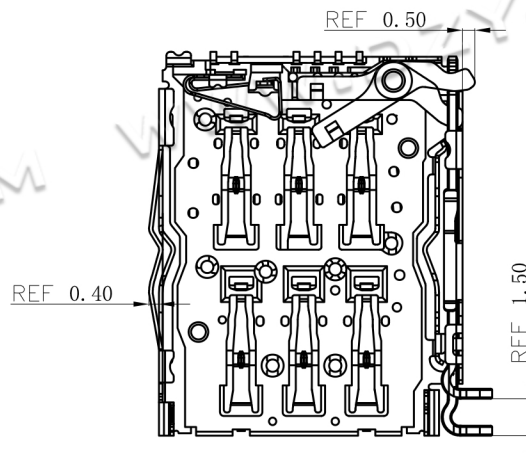




 深圳市华宇创精密电子有限公司			
TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.* ±2* X.X* ±0.5*	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 2.55H DUAL NANO SIM CARD
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYC306-SIM14-255
 UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 邱敏	DATE : 2014-02-23	MOLD NO. /
			DRAW NO: HYC-22041321616
			SHEET NO. 1 OF 1



 焊盘区域
 禁布区域

下层BlockPin脚定义	
M1	VCC
M2	RST
M3	CLK
M5	GND
M6	VPP
M7	I/O

- 3.1 Rated current:0.3A
- 3.2 Rated voltage:10V
- 3.3 Contact Resistance:150mΩ MAX
- 3.4 SWITCH CONTACT RESISTANCE:150mΩ MAX
- 3.5 Insulation Resistance:100MΩ MIN 500V DC
- 3.5 Dielectric withstanding voltage: 500V AC.
- 3.6 OPERATING TEMPERATURE RANGE:-30° C~+85° C
- 3.7 Durability:3000 Cycles Min.



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TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.* ±2* X.X* ±0.5*		DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 2.55H DUAL NANO SIM CARD	
 UNIT: mm [inch]		CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYC306-SIM14-255	
		APPROVED BY: 邱敏	DATE : 2014-02-23	MOLD NO. 	
SCALE:1:1	SIZE: A4			DRAW NO: HYC-22041321616	
				SHEET NO. 1 OF 1	

